TCAD simulation IIII

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• Simulation example of 2D PN junction using SDEVICE

• Charge generation and collection



TCAD simulation SDEVICE

- Sentaurus Device is a numeric semiconductor device simulator, capable of simulating the electrical, thermal, and optical characteristics of various semiconductor devices.
- It simulates 1D, 2D, and 3D device behaviour over a wide range of operating conditions, including mixed-mode circuit simulation, combining numerically simulated devices with their compact modeling, which is performed on a SPICE-based circuit simulation level.

1 File Section: input/output files



2 **Electrode Section**: electrode definition, matching those in the input grid

3 **Physics Section**: physics models to use in the simulation

4 Plot Section: variables to plot

5 Math Section: solvers

6 Solve Section: what to solve (IV,CV, Charge injection)

A typical command file of Sentaurus Device consists of several sections (or statement blocks), with each section executing a relatively independent function. The default extension of the command file is _des.cmd, for example, pp1_des.cmd. To start: **sdevice**



- SDEVICE simulation of 2D pn junction
 - Charge generation
- Within SDEVICE, charge injection by particles can be modelled using the models for carrier generation by gamma radiation, alpha particles and heavy ions (optical generation is also available)
- Heavylon generation:

G(I,w,t)=Glet(I)R(w,I)T(t)

Glet: linear energy transfer(LET) generation density R(w,t): spatial distribution (exponential/Gaussian) T(t): temporal profile





- SDEVICE command file: transient analysis:
 - File Section: input/output files
 Electrode Section: electrode definition, matching those in the input grid
 - **Physics Section**: physics models to use in the simulation
 - System: defines a mixed mode setup consisting of the device(s) and sources attached to it
 Plot Section: variables to plot
 - Math Section: solvers to use

######

#define Vdd @Vbias@
#define HitTime 1e-8
#define HitTime_Step 1e-11
#define Transient_Time 5e-9

Input and Output Files

Device PNjnct {

File {

grid = "2D_PNjnct_msh.tdr"
}



- SDEVICE command file: physics section
 - The ionisation is obtained by a Minimum Ionising Particle (MIP)
 - Details of the ionisation are included in a file (MIP_EXC) which has the LET and spatial parameters required for MIP emulation

Physics {

####if "@Ionization@" =="MIP"

```
#include "MIP_EXC"
```

...

#define WT_hi 0.1

Heavylon (

Time = HitTime

Location = (0, 0) ### Hits at the top surface, right in the middle of the device Direction = (1.0,0.0) ### Perpendicular hit

###LET_f = [1.28e-5 1.28e-5 1.28e-5] ### 80 e/h per micron is 1.28E-5 for THICK sensor LET_f = [1.056e-5 1.056e-5 1.056e-5] ### 66 e/h per micron as MPV for 50 um thick active region

LET_f = [1.15e-5 1.15e-5 1.15e-5] ### 72 e/h per micron as MPV for 300 um thick active region

```
Wt_hi = [WT_hi WT_hi WT_hi ] ### ro = 0.1/0.2 micron
Length = [ 0.0 20 60 ] ### LET @ different depths, irrelevant for a MIP
PicoCoulomb
Gaussian
```



Solve procedure Solve {

Coupled(Iterations= 700 LineSearchDamping= 1e-4){ Poisson }

```
Coupled(Iterations= 70 LineSearchDamping= 1e-4){ Poisson Electron Hole } ### DC bias
```

NewCurrentPrefix="2D_PNjnct_Temp@Temp@_CCE_DCVbias@Vbias@"

ramps up to the max Vbias for CCE investigation

```
Quasistationary
( InitialStep= 1e-3 MinStep= 1e-15 MaxStep= 0.25
Increment= 2.0 Decrement= 4.0
Goal { Parameter = vc.dc voltage = Vdd }
)
{ Coupled { Poisson Electron Hole } }
```

```
### Starts the transient
```

MinStep = 1e-15)

NewCurrentPrefix="2D_PNjnct_Temp@Temp@_CCE_TRVbias@Vbias@"

initial reset time until HIT_Time - 10ps...

```
Transient ( InitialTime = 0 FinalTime = @<HitTime-0.01e-9>@
```

```
InitialStep = 1e-9 MaxStep = 2e-9
```

Coupled (Iterations = 10) { Poisson Electron Hole }

```
imulation starts
is increase just before the
```

TCAD Synopsys Simulation

- SDEVICE command file: solve
 - The voltage is first ramped up to the required bias voltage
 - Then the transient simulation starts
 - The time resolution is increase just before the hit



- SDEVICE command file: solve
 - When the particle hits the devices, the temporal resolution is optimised for the first ns, it is relaxed afterwards

starts the transient analysis in 'HiRes' , set by Hit_Time_Step, until Hit_time + 1 ns

```
InitialTime = @<HitTime-0.01e-9>@
                            Transient (
FinalTime = @<HitTime+1e-9>@
                                                        InitialStep = 0.1e-12 MaxStep
= HitTime Step MinStep = 1e-15)
                                          { Coupled (Iterations = 5) { Poisson
Electron Hole }
                            Plot ( FilePrefix =
"2D PNinct Temp@Temp@ CCE TRVbias@Vbias@"
                               Time = (
                                                         HitTime
                                                        ) NoOverwrite )
  ### after the first 1 ns after the hit the transient is in 'MediumRes' of 0.1 ns
```

```
Transient ( InitialTime = @<HitTime+1e-9>@ FinalTime =
@<HitTime+Transient_Time>@
InitialStep = 1e-12 MaxStep =
.1e-9 MinStep = 1e-15 )
{
Coupled (Iterations = 10 ) { Poisson
Electron Hole }
```



- Visualize the resulting mesh using SVISUAL
 - Re-mesh the structure changing the p doping
 - Visualise the meshing
 - I transient vs. bias
 - Charge collected vs. bias
 - Plots of charge density vs. time



Icathode transient – MIP hit @ 10 ns -: No Ramo's theorem used

$$Q = \oint \varepsilon \vec{E} \cdot dS$$

Icathode transient – MIP hit @ 0, 100,200,500 ps





TCAD and simulation I

Thank you

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- Simulation example : 2D pn using SDEVICE
- Charge generation and collection from MIP hit

